

MM54HC237/MM74HC237 3-to-8 Line Decoder With Address Latches

General Description

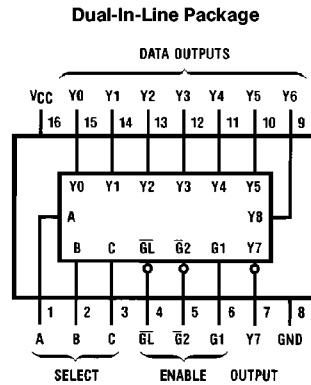
These devices utilize advanced silicon-gate CMOS technology, to implement a three-to-eight line decoder with latches on the three address inputs. When $\overline{GL}$ goes from low to high, the address present at the select inputs (A, B and C) is stored in the latches. As long as $\overline{GL}$ remains high no address changes will be recognized. Output enable controls, G1 and $\overline{G2}$, control the state of the outputs independently of the select or latch-enable inputs. All of the outputs are low unless G1 is high and $\overline{G2}$ is low. The 'HC237 is ideally suited for the implementation of glitch-free decoders in stored-address applications in bus oriented systems.

The 54HC/74HC logic family is speed, function and pin-out compatible with the standard 54LS/74LS logic family. All inputs are protected from damage due to static discharge by diodes to V_{CC} and ground.

Features

- Typical propagation delay: 20 ns
- Wide supply range: 2–6V
- Latched inputs for easy interfacing
- Fanout of 10 LS-TTL loads

Connection Diagram



TL/F/5326-1

Top View

Order Number MM54HC237 or MM74HC237

Truth Table

INPUTS						OUTPUTS							
ENABLE			SELECT										
$\overline{GL}$	G1	$\overline{G2}$	C	B	A	Y0	Y1	Y2	Y3	Y4	Y5	Y6	Y7
X	X	H	X	X	X	L	L	L	L	L	L	L	L
X	L	X	X	X	X	L	L	L	L	L	L	L	L
L	H	L	L	L	L	H	L	L	L	L	L	L	L
L	H	L	L	L	H	L	H	L	L	L	L	L	L
L	H	L	L	H	L	L	L	H	L	L	L	L	L
L	H	L	L	H	H	L	L	L	H	L	L	L	L
L	H	L	H	L	L	L	L	L	L	H	L	L	L
L	H	L	H	L	H	L	L	L	L	L	H	L	L
L	H	L	H	H	L	L	L	L	L	L	L	H	L
L	H	L	H	H	H	L	L	L	L	L	L	L	H
H	H	L	X	X	X	Output corresponding to stored address, L; all others, H							

H = high level, L = low level, X = irrelevant

Absolute Maximum Ratings (Notes 1 & 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage (V_{CC})	−0.5 to +7.0V
DC Input Voltage (V_{IN})	−1.5 to V_{CC} + 1.5V
DC Output Voltage (V_{OUT})	−0.5 to V_{CC} + 0.5V
Clamp Diode Current (I_{IK} , I_{OK})	±20 mA
DC Output Current, per pin (I_{OUT})	±25 mA
DC V_{CC} or GND Current, per pin (I_{CC})	±50 mA
Storage Temperature Range (T_{STG})	−65°C to +150°C
Power Dissipation (P_D)	
(Note 3)	600 mW
S.O. Package only	500 mW
Lead Temperature	
(T_L) (Soldering 10 seconds)	260°C

Operating Conditions

	Min	Max	Units
Supply Voltage (V_{CC})	2	6	V
DC Input or Output Voltage (V_{IN} , V_{OUT})	0	V_{CC}	V
Operating Temp. Range (T_A)			
MM74HC	−40	+85	°C
MM54HC	−55	+125	°C
Input Rise or Fall Times (t_r , t_f)			
V_{CC} = 2.0V		1000	ns
V_{CC} = 4.5V		500	ns
V_{CC} = 6.0V		400	ns

DC Electrical Characteristics (Note 4)

Symbol	Parameter	Conditions	V _{CC}	T _A = 25°C		74HC T _A = −40 to 85°C	54HC T _A = −55 to 125°C	Units
				Typ	Guaranteed Limits			
V _{IH}	Minimum High Level Input Voltage		2.0V		1.5	1.5	1.5	V
			4.5V		3.15	3.15	3.15	V
			6.0V		4.2	4.2	4.2	V
V _{IL}	Maximum Low Level Input Voltage**		2.0V		0.5	0.5	0.5	V
			4.5V		1.35	1.35	1.35	V
			6.0V		1.8	1.8	1.8	V
V _{OH}	Minimum High Level Output Voltage	V _{IN} = V _{IH} or V _{IL} I _{OUT} ≤ 20 μA	2.0V	2.0	1.9	1.9	1.9	V
			4.5V	4.5	4.4	4.4	4.4	V
			6.0V	6.0	5.9	5.9	5.9	V
		V _{IN} = V _{IH} or V _{IL} I _{OUT} ≤ 4.0 mA I _{OUT} ≤ 5.2 mA	4.5V	4.2	3.98	3.84	3.7	V
			6.0V	5.7	5.48	5.34	5.2	V
V _{OL}	Maximum Low Level Output Voltage	V _{IN} = V _{IH} or V _{IL} I _{OUT} ≤ 20 μA	2.0V	0	0.1	0.1	0.1	V
			4.5V	0	0.1	0.1	0.1	V
			6.0V	0	0.1	0.1	0.1	V
		V _{IN} = V _{IH} or V _{IL} I _{OUT} ≤ 4.0 mA I _{OUT} ≤ 5.2 mA	4.5V	0.2	0.26	0.33	0.4	V
			6.0V	0.2	0.26	0.33	0.4	V
I _{IN}	Maximum Input Current	V _{IN} = V _{CC} or GND	6.0V		±0.1	±1.0	±1.0	μA
I _{CC}	Maximum Quiescent Supply Current	V _{IN} = V _{CC} or GND I _{OUT} = 0 μA	6.0V		8.0	80	160	μA

Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur.

Note 2: Unless otherwise specified all voltages are referenced to ground.

Note 3: Power Dissipation temperature derating — plastic "N" package: −12 mW/°C from 65°C to 85°C; ceramic "J" package: −12 mW/°C from 100°C to 125°C.

Note 4: For a power supply of 5V ±10% the worst case output voltages (V_{OH} , and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at $V_{CC} = 5.5\text{V}$ and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage current (I_{IN} , I_{CC} , and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0V values should be used.

** V_{IL} limits are currently tested at 20% of V_{CC} . The above V_{IL} specification (30% of V_{CC}) will be implemented no later than Q1, CY'89.

AC Electrical Characteristics $V_{CC}=5V$, $T_A=25^{\circ}C$, $C_L=15\text{ pF}$, $t_r=t_f=6\text{ ns}$

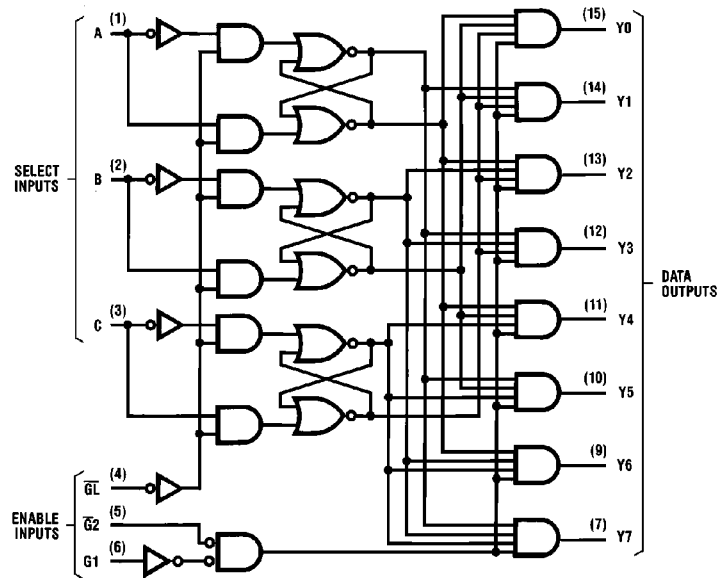
Symbol	Parameter	Conditions	Typ	Guaranteed Limit	Units
t_{PLH}	Maximum Propagation Delay A, B or C to any Y Output		20	41	ns
t_{PLH}	Maximum Propagation Delay A, B or C to any Y Output		16	32	ns
t_{PLH}	Maximum Propagation $\overline{GL}$ to any Y Output		22	44	ns
t_{PHL}	Maximum Propagation Delay $\overline{GL}$ to any Y Output		17	33	ns
t_{PLH}	Maximum Propagation Delay G1 or $\overline{G2}$ to Output		16	35	ns
t_{PHL}	Maximum Propagation Delay G1 or $\overline{G2}$ to Output		14	25	ns
t_S	Minimum Set Up Time at A, B and C Inputs		10	20	ns
t_H	Minimum Hold Time at A, B and C Inputs		-3	0	ns
t_W	Minimum Pulse Width of Enabling Pulse at $\overline{GL}$		9	16	ns

AC Electrical Characteristics $C_L=50\text{ pF}$, $t_r=t_f=6\text{ ns}$ (unless otherwise specified)

Symbol	Parameter	Conditions	V _{CC}	T _A = 25°C		74HC T _A = −40 to 85°C		54HC T _A = −55 to 125°C		Units
				Typ	Guaranteed Limits					
t _{PLH}	Maximum Propagation Delay, A, B or C to any Y Output		2.0V	100	235	296		350		ns
			4.5V	24	47	59		70		ns
			6.0V	20	40	50		60		ns
t _{PLH}	Maximum Propagation Delay, A, B or C to any Y Output		2.0V	80	185	233		276		ns
			4.5V	19	37	47		55		ns
			6.0V	17	31	40		47		ns
t _{PLH}	Maximum Propagation <u>GL</u> to any Y Output		2.0V	125	250	315		373		ns
			4.5V	25	50	63		75		ns
			6.0V	20	43	54		63		ns
t _{PHL}	Maximum Propagation Delay <u>GL</u> to any Y Output		2.0V	95	190	239		283		ns
			4.5V	19	38	48		75		ns
			6.0V	16	32	41		48		ns
t _{PLH}	Maximum Propagation Delay, G1 or <u>G</u> 2 to Output		2.0V	100	200	252		298		ns
			4.5V	20	40	50		60		ns
			6.0V	17	34	43		51		ns
t _{PHL}	Maximum Propagation Delay G1 or <u>G</u> 2 to Output		2.0V	73	145	183		216		ns
			4.5V	15	29	37		43		ns
			6.0V	12	25	31		37		ns
t _S	Minimum Set Up Time at A, B and C Inputs		2.0V		100	125		150		ns
			4.5V		20	25		30		ns
			6.0V		17	21		25		ns
t _H	Minimum Hold Time at A, B and C Inputs		2.0V		0	0		0		ns
			4.5V		0	0		0		ns
			6.0V		0	0		0		ns
t _W	Minimum Pulse Width of Enabling Pulse at <u>GL</u>		2.0V	30	80	100		120		ns
			4.5V	10	16	20		24		ns
			6.0V	9	14	18		20		ns
t _{TLH} , t _{THL}	Maximum Output Rise and Fall Time		2.0V	30	75	95		110		ns
			4.5V	8	15	19		22		ns
			6.0V	7	13	16		19		ns
C _{PD}	Power Dissipation Capacitance (Note 5)			75						pF
C _{IN}	Maximum Input Capacitance			5	10	10		10		pF

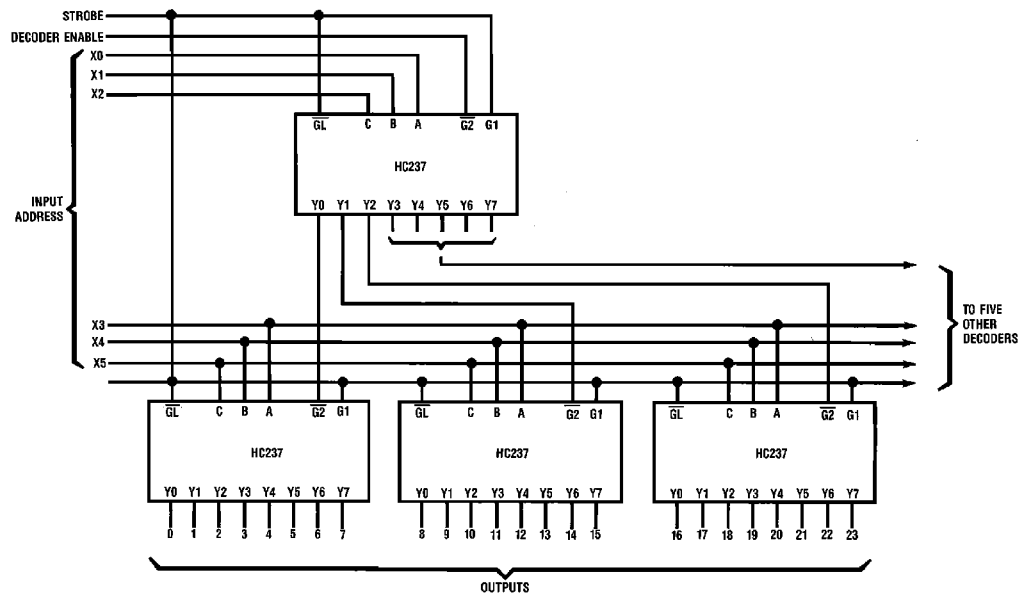
Note 5: C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC} f + I_{CC}$.

Functional Block Diagram



TL/F/5326-2

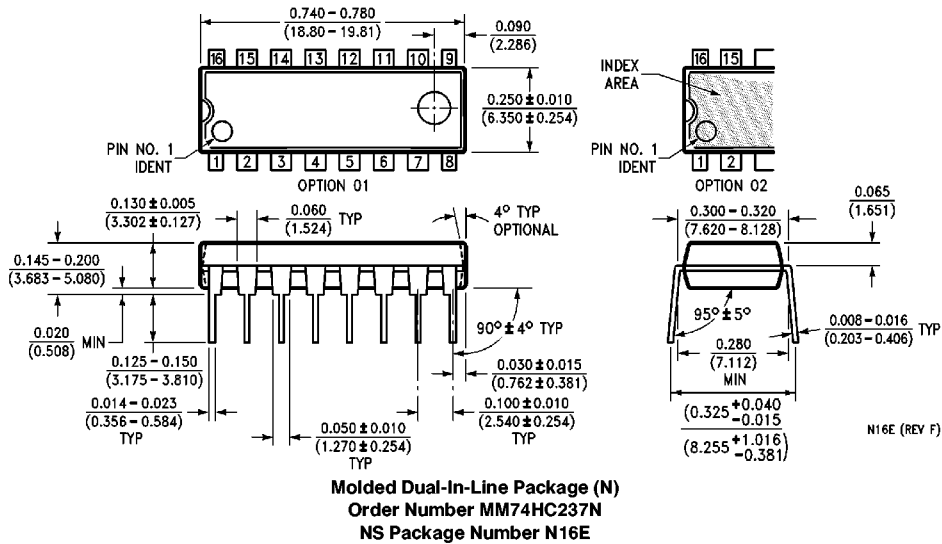
Typical Application



TL/F/5326-3

6-Line to 64-Line Decoder with Input Address Storage

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Physical Dimensions inches (millimeters) (Continued)**LIFE SUPPORT POLICY**

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